

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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SURFACE MOUNT SCHOTTKY BARRIER DIODE

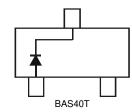
Features

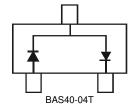
- Low Forward Voltage Drop
- Fast Switching
- Ultra-Small Surface Mount Package
- PN Junction Guard Ring for Transient and ESD Protection
- Lead, Halogen and Antimony Free, RoHS Compliant "Green" Device (Notes 3, 4 and 5)

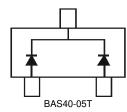
Mechanical Data

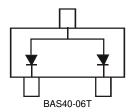
- Case: SOT-523
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagrams Below
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.002 grams (approximate)











Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	40	V
RMS Reverse Voltage		$V_{R(RMS)}$	28	V
Forward Continuous Current	(Note 1)	I _{FM}	200	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0s	I _{FSM}	600	mA

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Power Dissipation	(Note 1)	P_{D}	150	mW
Thermal Resistance Junction to Ambient	(Note 1)	$R_{\theta JA}$	833	°C/W
Operating Temperature Range		TJ	-55 to +125	°C
Storage Temperature Range		T _{STG}	-65 to +150	°C

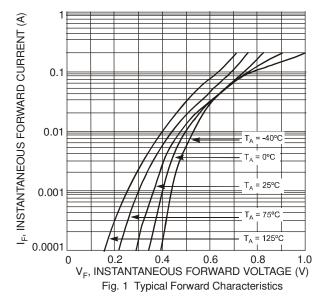
Electrical Characteristics @TA = 25°C unless otherwise specified

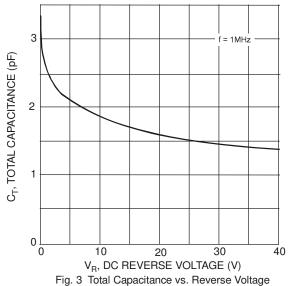
Characteristic	Symbol	Min	Max	Unit	Test Condition	
Reverse Breakdown Voltage	(Note 2)	$V_{(BR)R}$	40	_	V	$I_R = 10\mu A$
Forward Voltage		V _F	_	380 1000	mV mV	$I_F = 1.0 \text{mA}, t_p < 300 \mu \text{s}$ $I_F = 40 \text{mA}, t_p < 300 \mu \text{s}$
Leakage Current	(Note 2)	I _R	_	200	nA	$V_R = 30V$
Total Capacitance		Ст	_	5.0	pF	$V_R = 0, f = 1.0MHz$
Reverse Recovery Time		t _{rr}	_	5.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$

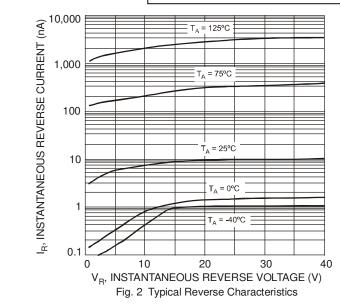
Notes:

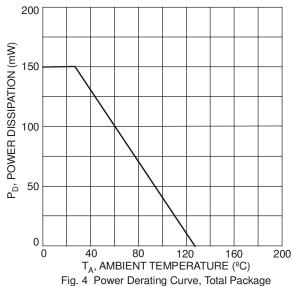
- Device mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 2. Short duration pulse test used to minimize self-heating effect.
- 3. No purposefully added lead. Halogen and Antimony Free.
- 4. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- 5. Product manufactured with Green Molding Compound and does not contain Halogens or Sb₂O₃ Fire Retardants.











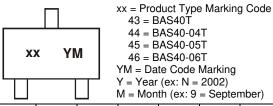
Ordering Information (Note 6)

Part Number	Case	Packaging
BAS40T-7-F	SOT-523	3000/Tape & Reel
BAS40-04T-7-F	SOT-523	3000/Tape & Reel
BAS40-05T-7-F	SOT-523	3000/Tape & Reel
BAS40-06T-7-F	SOT-523	3000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

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Marking Information



	Date Code Key				Ш	L		M = Mon	th (ex: 9	e Septe	mber)					
	Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015
	Code	М	N	Р	R	S	Т	U	V	W	Χ	Υ	Z	Α	В	С
_						_								-		
	Month	l Jan	l Fe	b I I	Mar	Apr	Mav	Ju	ın I	Jul	Aua	Sep	Oc	t I	Nov	Dec

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Code

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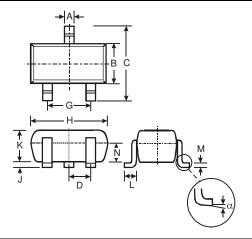
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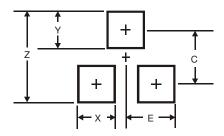


Package Outline Dimensions



	SOT-523							
Dim	Dim Min Max Typ							
Α	0.15	0.30	0.22					
В	0.75	0.85	0.80					
С	1.45	1.75	1.60					
D	D — — 0.50							
G	3 0.90 1.10 1.00							
Н	1.50	1.70	1.60					
J	0.00	0.10	0.05					
K 0.60 0.80 0.7								
L	L 0.10 0.30 0.22							
М	0.10	0.20	0.12					
N	N 0.45 0.65 0							
α	α 0° 8° —							
All Dimensions in mm								

Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.8
Х	0.4
Υ	0.51
С	1.3
E	0.7

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